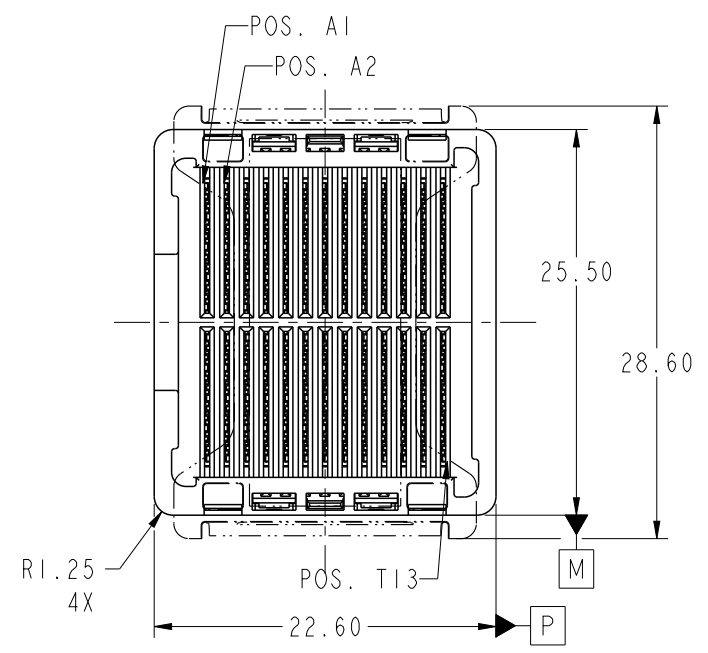
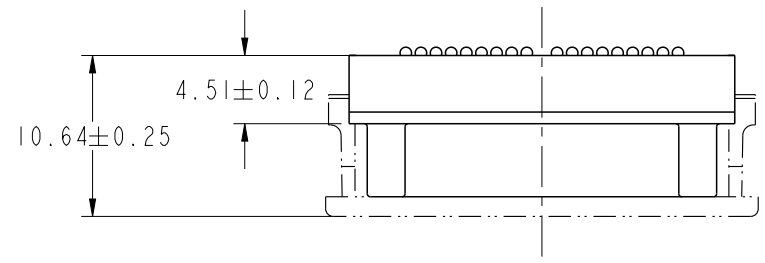
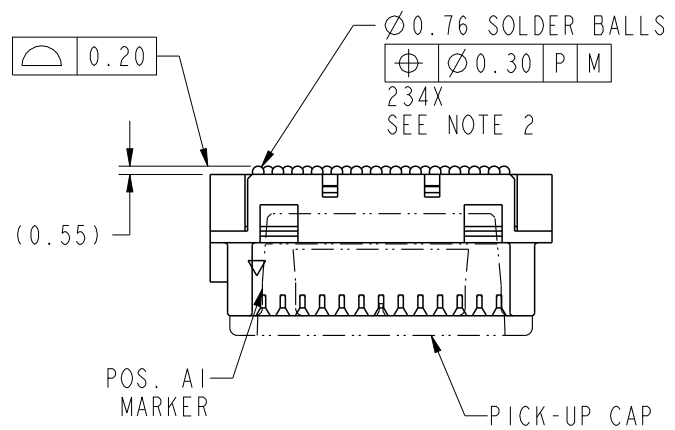




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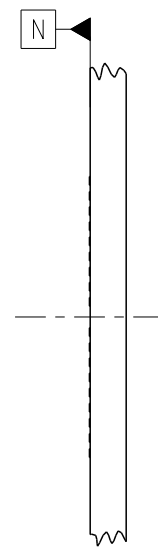
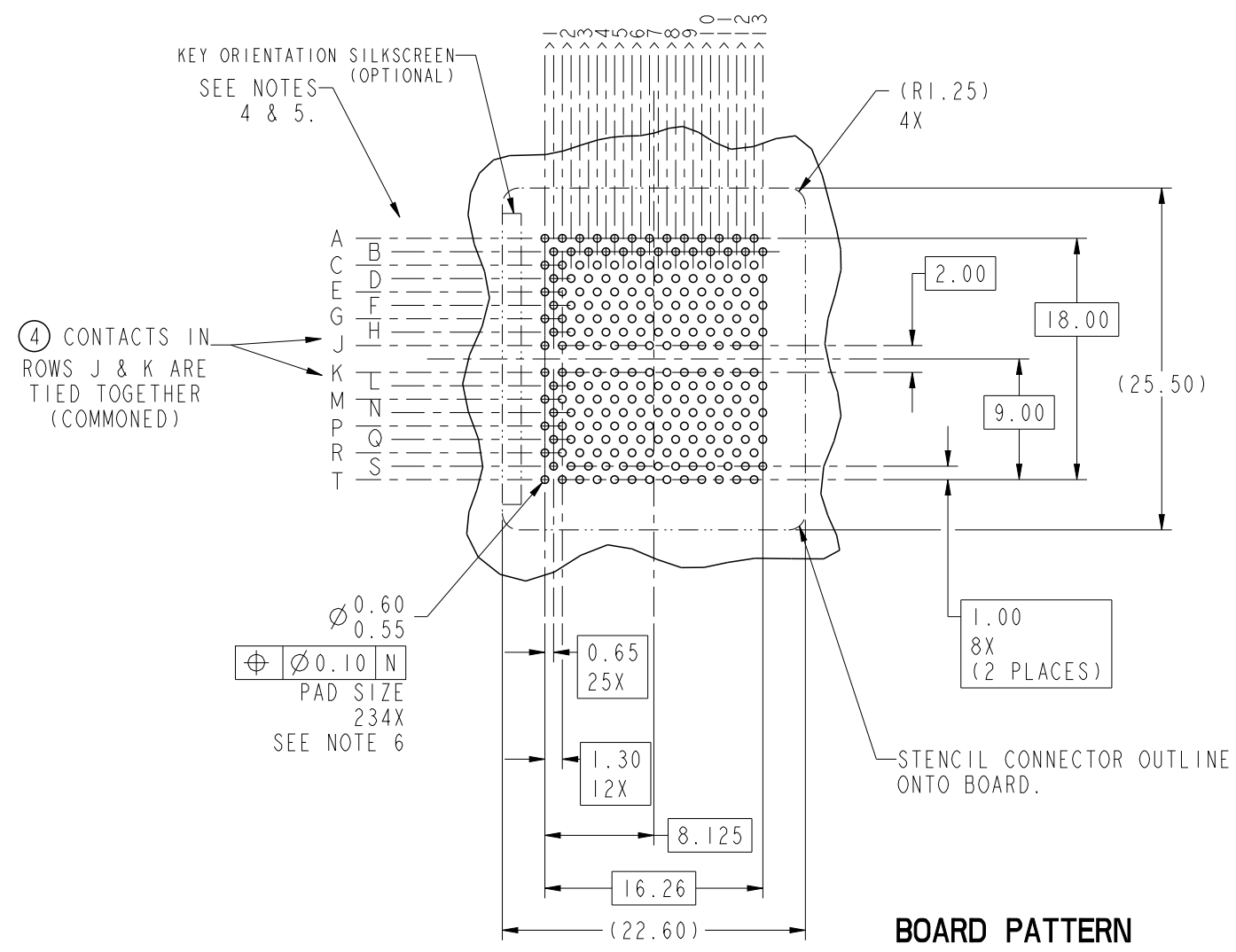


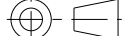
spec ref				dr	Tao Zhan	2012/11/14	projection 	MM 	size	A4	scale	2:1
tolerance std	TOLERANCES UNLESS OTHERWISE SPECIFIED			eng	Sky Chen	2013/10/17			ecn no	-		
				chr	-	-						
				appr	Pei-Ming Zheng	2013/10/17						
surface 	linear	0.X	±0.30		title GIG-Array 5mm RECP. ASSY. 104 SIG. POS.				dwg no	10014370		rev A
		0.XX	±0.20									
		0.XXX	±0.10									
	angular	0°	±2°	www.fci.com	cat. no.			Product - Customer Drw			sheet 1 of 4	

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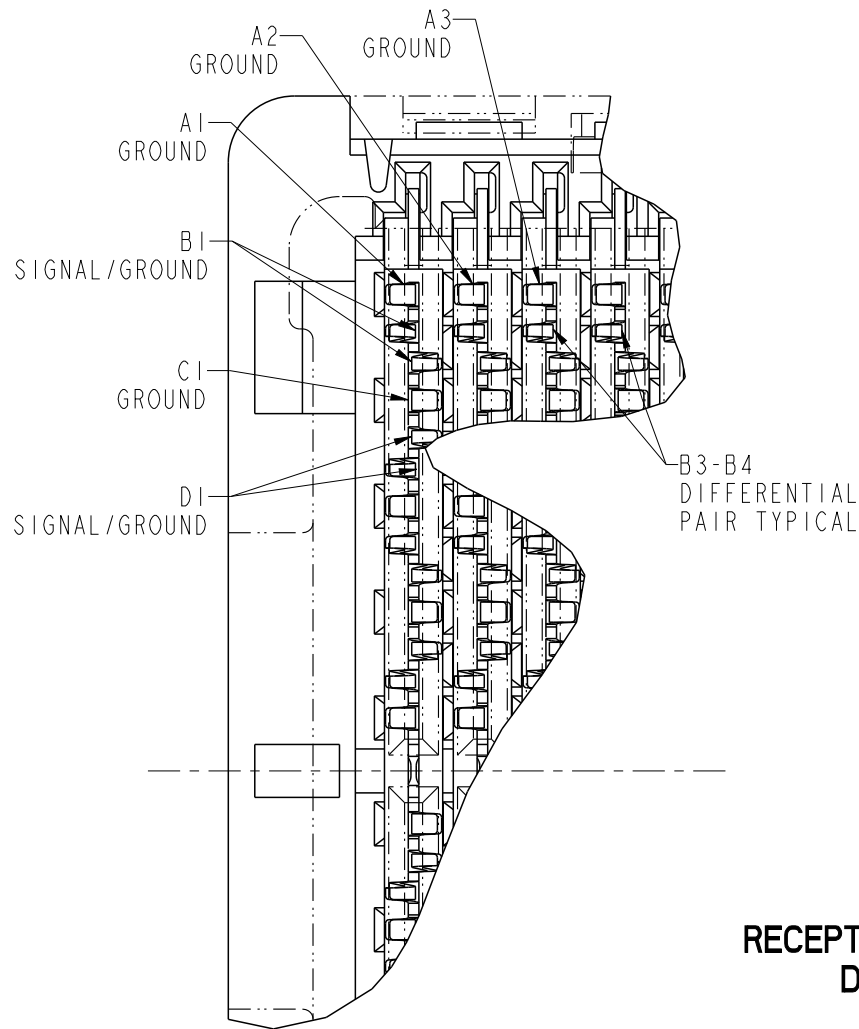


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spec ref				dr	Tao Zhan	2012/11/14	projection 	MM 	size	A4	scale	2:1
tolerance std	TOLERANCES UNLESS OTHERWISE SPECIFIED			eng	Sky Chen	2013/10/17			ecn no	-		
				chr	-	-		rel level		Released		
				appr	Pei-Ming Zheng	2013/10/17		product family		GIG-Array		
surface ✓	linear	0.X	±0.30	FCi www.fci.com	title			dwg no	10014370		rev	A
		0.XX	±0.20									
		0.XXX	±0.10		5mm RECP. ASSY. 104 SIG. POS.							
	angular	0°	±2°						cat. no.			

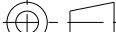
Print File - REV C - 2009-06-09



NOTES:

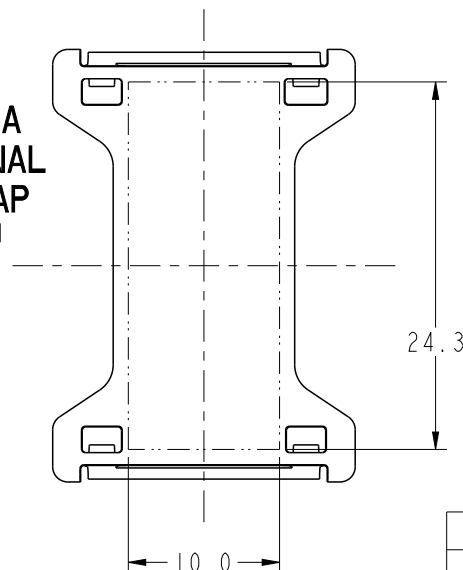
- ① MATERIAL:
HOUSING: LCP
UL RATING: 94 V-0
CONTACT: COPPER ALLOY
PLATING (CONTACT): Au OVER Ni.
SOLDERBALL: (SEE TABLE) EUTECTIC
SnPb OR LEAD FREE 95.5 Sn/4Ag/0.5Cu.
- ② SOLDER BALLS WILL NOT BE PERFECT
SPHERICAL SHAPE DUE TO REFLOW ATTACHMENT.
- ③ MATED HEIGHT EFFECTED BY CUSTOMERS'
PCB PAD SIZE, PLATING, SOLDER REFLOW
PROFILE & SOLDER PASTE.
- ④ CONTACTS IN ROWS A,C,E,G,J,K,M,P,R AND T
ARE SINGLE BEAM CONTACTS,
TYPICALLY USED AS GROUND PINS.
(NOTE: CONTACTS IN ROWS J & K ARE
TIED TOGETHER [COMMONED])
- ⑤ CONTACTS IN ROWS B,D,F,H,L,N,Q AND S
ARE DUAL BEAM CONTACTS,
TYPICALLY USED AS SIGNAL PINS.

RECEPTACLE INTERFACE DESCRIPTION

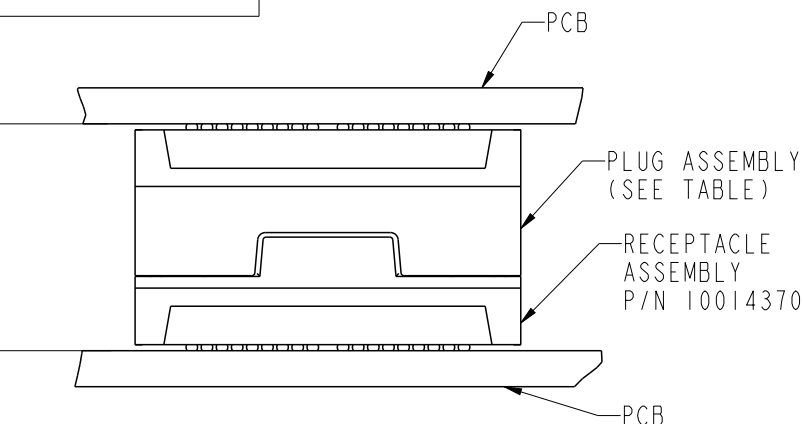
spec ref				dr		Tao Zhan	2012/11/14	projection 	MM 	size	A4	scale	7:1	
tolerance std	TOLERANCES UNLESS OTHERWISE SPECIFIED			eng		Sky Chen	2013/10/17			ecn no				-
				chr		-	-							
				appr		Pei-Ming Zheng	2013/10/17			product family		GIG-Array	rel level	
surface	linear	0.X	±0.30		title				GIG-Array	dwg no	10014370		rev	A
		0.XX	±0.20											
		0.XXX	±0.10											
	angular	0°	±2°	www.fci.com	cat. no.			Product - Customer Drw			sheet 3 of 4			

PRODUCT NUMBER	SOLDER BALL COMPOSITION	CONTACT PLATING PERFORMANCE LEVEL
10014370-001	STAND (EUTECTIC)	PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-192, INCLUDING TELCORDIA CENTRAL OFFICE
10014370-001LF	LEADFREE	
10014370-201	STAND (EUTECTIC)	
10014370-201LF	LEADFREE	
		Au OVER Ni

FLAT AREA
FOR OPTIONAL
PICK-UP CAP
SCALE 2:1



DIM "A" REF.
MATED HEIGHT
AFTER REFLOW
SEE NOTE 3.



END VIEW OF MATED CONNECTORS

SCALE 2:1

DIM "A"	PLUG PART NUMBER
20	10098180
25	10122145

6. SPECIFIED POSITIONAL TOLERANCE DEFINES PAD TO PAD LOCATION WITHIN LAND PATTERN. POSITIONAL TOLERANCE OF LAND PATTERN TO FUDICIAL MARKS OR PCB DATUMS SHALL BE DEFINED BY CUSTOMER. FOR RECOMMENDED PRODUCT APPLICATION AND PCB DESIGN DETAILS, SEE DOC. NO. GS-20-016.

7. FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033. LEAD FREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE. LEADFREE PRODUCT IS THEREFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION.

8. THIS PRODUCT MEETS THE EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008. PRODUCT MEETING THIS DIRECTIVE IS IDENTIFIED IN THE CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSTION.

spec ref				dr	Tao Zhan	2012/11/14	projection	MM	size	A4	scale	2:1		
tolerance std	TOLERANCES UNLESS OTHERWISE SPECIFIED			eng	Sky Chen	2013/10/17								
				chr	-	-								
				appr	Pei-Ming Zheng	2013/10/17			product family		GIG-Array	ecn no	-	rel level
surface	linear	0.X	±0.30		title	GIG-Array			dwg no	10014370			rev	A
		0.XX	±0.20											
		0.XXX	±0.10											
	angular	0°	±2°											

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